

Tripple Output AMOLED Bias Evaluation Board

General Description

The RT4730 is a highly integrated Boost, LDO and inverting charge pump to generate positive and negative output voltage. The negative output voltages can be adjusted from $-0.6V$ to $-4V$ with 100mV steps.

The positive output voltages can be adjusted from 2.8V to 4V with 100mV steps by SWIRE interface protocol. With its input voltage range of 2.9V to 5.2V, the RT4730 is optimized for products powered by single-cell battery and the output current up to 50mA.

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Performance Sepcification Summary

Summary of the RT4730 Evaluation Board performance specificiaiton is provided in Table 1. The ambient temperature is 25°C.

Table 1. RT4730 Evaluation Board Performance Specification Summary

Specification	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range		2.9	3.7	5.2	V
Quiescent Current	AVDDEN = high, SWIRE = high	200	400	500	μA
	AVDDEN = high, SWIRE = low	100	200	300	μA
Shutdown Current	AVDDEN = low, SWIRE = low	--	0.01	2	μA
Output Current		50	--	--	mA
Default Output Voltage	AVDD = 3.3V OVDD = 3.3V OVSS = -3.3V	--	3.3	--	V
Operation Frequency		2.75	--	3.25	MHz
Output Ripple Voltage	I _{LOAD} = 10mA	--	10	20	mVp-p
Output Voltage Accuracy	I _{LOAD} = 0mA	-1	--	1	%
Line Regulation	V _{IN} = 2.9V to 5.2V, I _{LOAD} = 10mA	--	±1	--	mV
Load Regulation	I _{LOAD} = 0mA to 10mA	--	±1	--	mV

Power-up & Measurement Procedure

1. Connect input power ($2.9V < V_{IN} < 5.2V$) and input ground to VIN and GND test pins respectively.
2. Connect positive end and negative terminals of load to OVDD and OVSS and AVDD test pins respectively.
3. There is a 3-pin header "SWIRE" and "AVDD_EN" for enable control. To use a jumper at "H" option (upper side) to tie SWIRE test pin to input power VIN for enabling the device. Inversely, to use a jumper at "L" option to tie SWIRE test pin and ground GND for disabling the device.
4. Verify the output voltage (typically 6.6V) between OVDD and OVSS.
5. Connect an external load up to 50mA to the OVDD and OVSS and AVDD terminals and verify the output voltage and current.

OVDD and OVSS Output Voltage Setting

Set the negative output voltage with the Single Wire Protocal (SWIRE). Send the specified pulses to the header of SWIRE to program the OVDD and OVSS voltage. The output voltage is set by the following table:

SWIRE Setting

Pulse	Function Description
0	Default value: OVDD = 3.3V, OVSS = -3.3V
116	OVDD is turned on
117	VON/OVSS is turned on
118	OVDD is turned off
119	VON/OVSS is turned off
120	VON/OVSS discharge to GND, with slow slew rate then enter high impedance state
121	Soft-reset, clear all setting and back to default state
10-22	OVDD setting (2.8V to 4V)
58-92	OVSS setting (-4V to -0.6V)

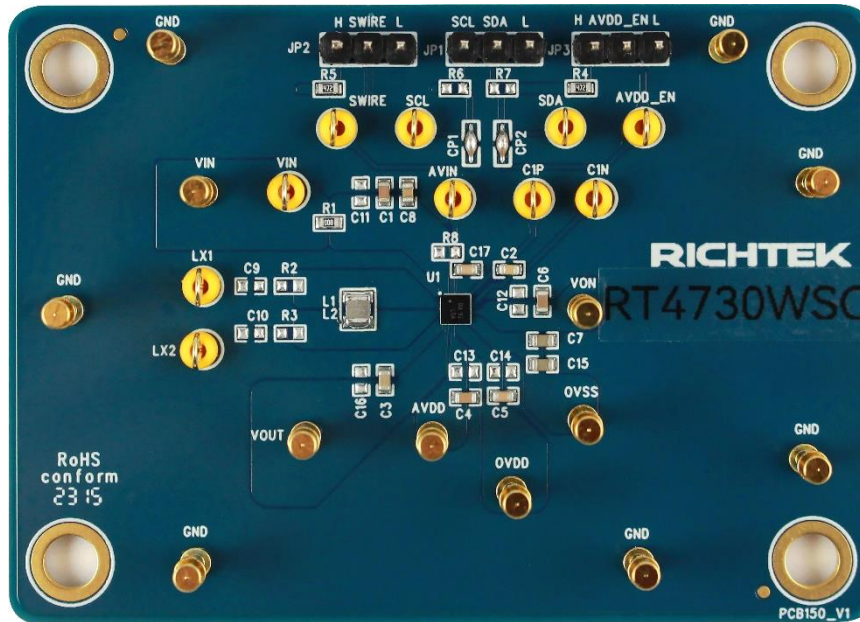
Pulse	VOUT	OVDD
10	3.5	2.8
11	3.5	2.9
12	3.5	3
13	3.5	3.1
14	3.5	3.2
15	3.5	3.3
16	3.6	3.4
17	3.7	3.5
18	3.8	3.6
19	3.9	3.7
20	4	3.8
21	4.1	3.9
22	4.2	4

Pulse	VON	OVSS	Pulse	VON	OVSS
58	-4.1	-4	76	-2.3	-2.2
59	-4	-3.9	77	-2.2	-2.1
60	-3.9	-3.8	78	-2.1	-2
61	-3.8	-3.7	79	-2	-1.9
62	-3.7	-3.6	80	-1.9	-1.8
63	-3.6	-3.5	81	-1.8	-1.7
64	-3.5	-3.4	82	-1.7	-1.6
65	-3.4	-3.3	83	-1.6	-1.5
66	-3.3	-3.2	84	-1.5	-1.4
67	-3.2	-3.1	85	-1.4	-1.3
68	-3.1	-3	86	-1.3	-1.2
69	-3	-2.9	87	-1.2	-1.1
70	-2.9	-2.8	88	-1.1	-1
71	-2.8	-2.7	89	-1	-0.9
72	-2.7	-2.6	90	-0.9	-0.8
73	-2.6	-2.5	91	-0.8	-0.7
74	-2.5	-2.4	92	-0.7	-0.6
75	-2.4	-2.3			

$$V_{OUT} = \text{MAX}(AVDD, OVDD, |OVSS|) + 0.2V$$

Detailed Description of Hardware

Headers Description and Placement



Carefully inspect all the components used in the EVB according to the following Bill of Materials table, and then make sure all the components are undamaged and correctly installed. If there is any missing or damaged component, which may occur during transportation, please contact our distributors or e-mail us at evb_service@richtek.com.

Test Points

The EVB is provided with the test points and pin names listed in the table below.

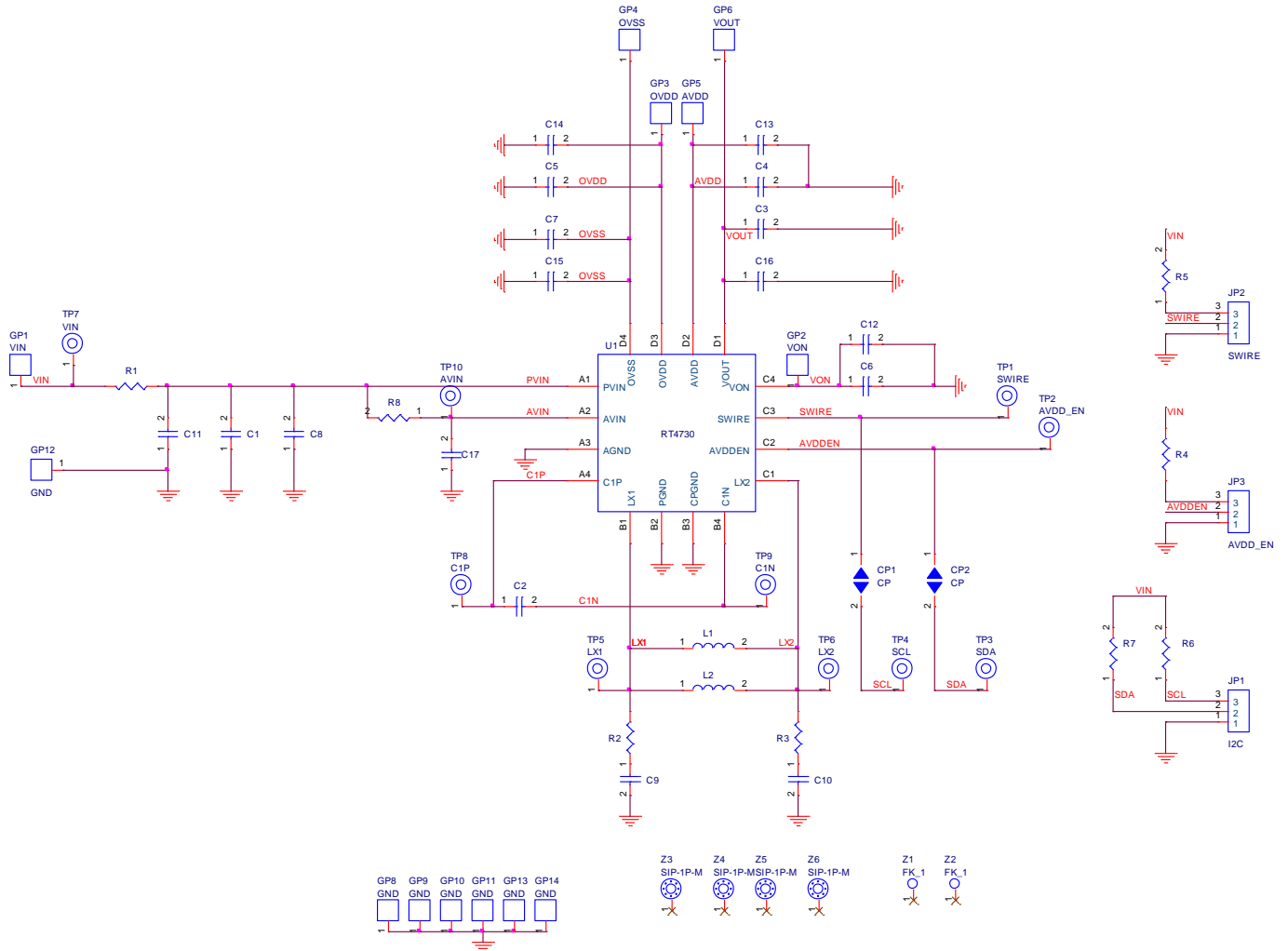
Test point/ Pin name	Signal	Comment (expected waveforms or voltage levels on test points)
VIN	Input voltage	Power input. Support 2.9V to 5.2V input coltage. Must bypass with a suitable large ceramic capacitor at this pin.
SWIRE	Single wire protocal	Enable and OVDD and OVSS voltage setting.
AVDDEN	Single wire protocal	Enable AVDD voltage.
VON	Negative charge pump output	Negative charge pump output. It's typically 3.3V.
GND	Ground	Ground.
VOUT	Buck-Boost voltage	Output voltage of boost converter. It's typically 3.5V.(default setting)
OVDD	Positive terminal output	The output of a LDO. It is set at a typical value of 3.3V, It is set at a typical value of 3.3V and can be programmed through SWIRE
OVSS	Negative terminal output	The output of an inverting charge pump. It is set at a typical value of -3.3V and can be programmed through SWIRE
AVDD	Positive terminal output	Output voltage of boost converter. It is typically 3.3V.
C1P, C1N	Flying capacitor 1 positive and negative connection	Connect 1 μ F between C1P and C1N for inverting charge pump operation.

Bill of Materials

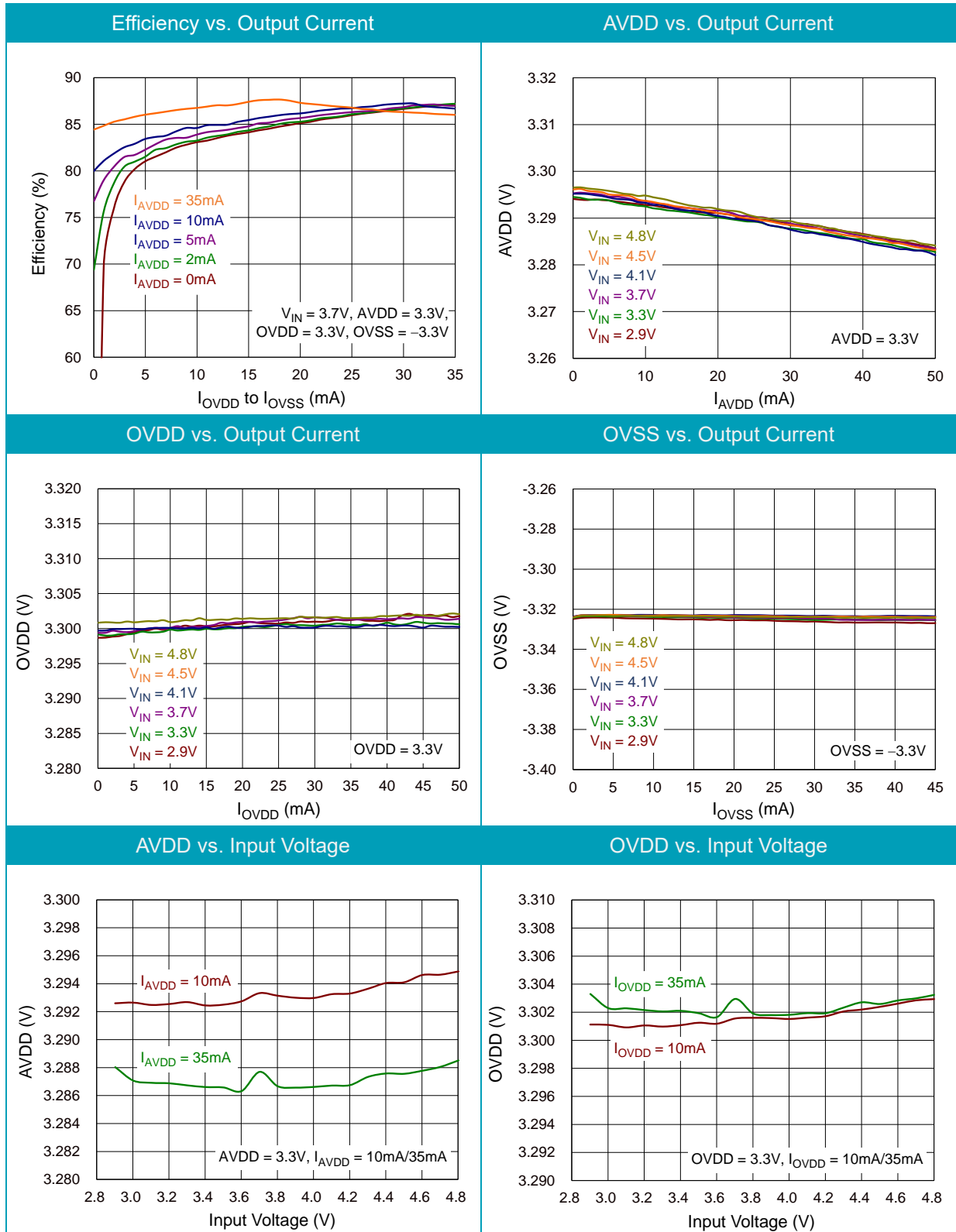
Reference	Qty	Part Number	Description	Package	Manufacture
U1	1	RT4730WSC	DC-DC Converter	WL-CSP-16B 2.34x2.34 (BSC)	RICHTEK
C1	1	C1608X5R1E475KT000E	4.7μF/25V/X5R	0603	TDK
C2	1	0603X105K250CT	1μF/25V/X5R	0603	WALSIN
C3, C5, C17	4	0603X106M6R3CT	10μF/6.3V/X5R	0603	WALSIN
C4, C6	2	0603X475K6R3CT	4.7μF/6.3V/X5R	0603	Murata
C7, C15	5	JMK107BBJ226MA-T	22μF/6.3V/X5R	0603	TAIYO YUDEN
C8	1	0603B104K500CT	0.1μF/50V/X5R	0603	WALSN
C9, C10, C11, C12, C13, C14, C16	8	NC	NC	0603	
L1	1	1269AS-H-2R2M	2.2μH	2.5x2.0x1.0mm	Murata
L2	1	1269AS-H-2R2M=P2	2.2μH	2520	Murata
R1	1	WR06X000 PTL	0	0603	WALSIN
R2, R3, R6, R7, R8	5	NC	NC	0603	
R4, R5	2	WR06X4701FTL	4.7k	0603	WALSIN
CP1, CP2	2		Short	0603	

Typical Applications

EVB Schematic Diagram



Measure Result





Evaluation Board Layout

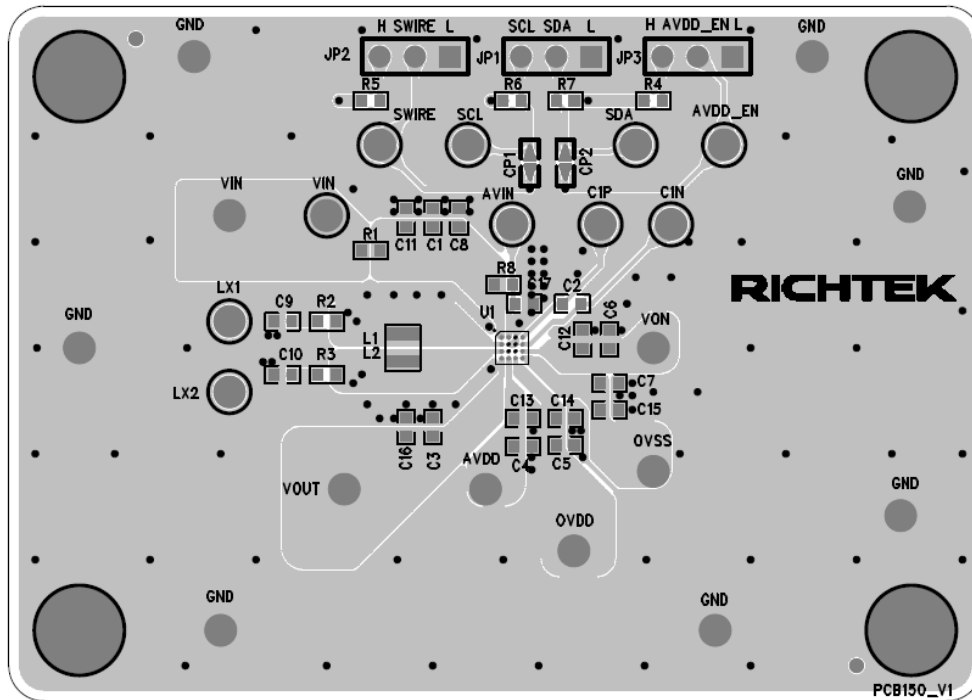


Figure 1. Top View (1st layer)

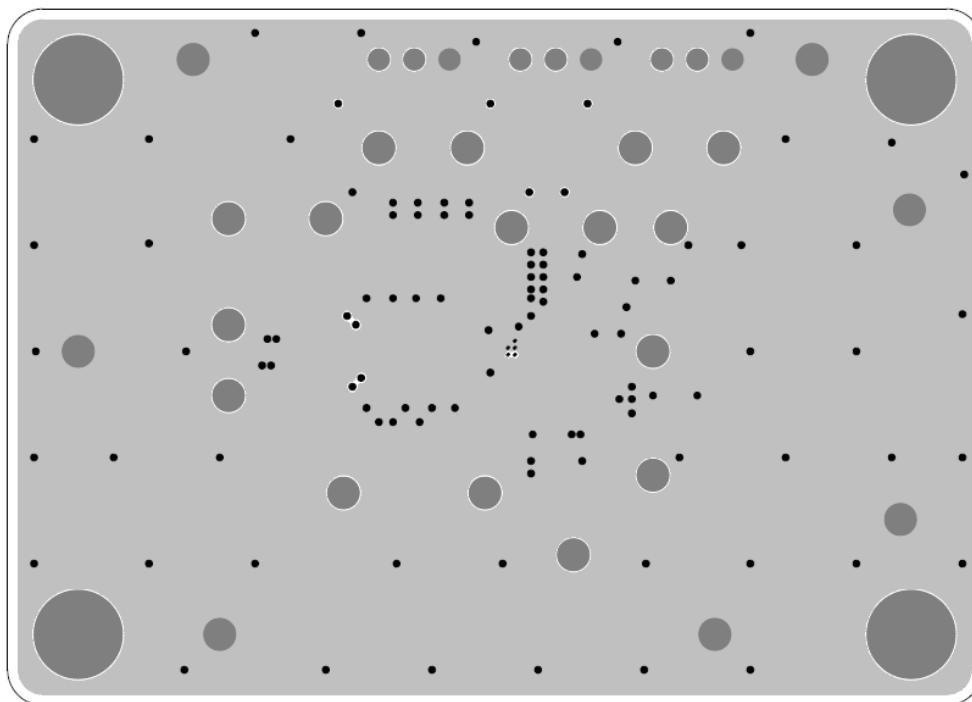


Figure 2. PCB Layout—Inner Side (2nd Layer)

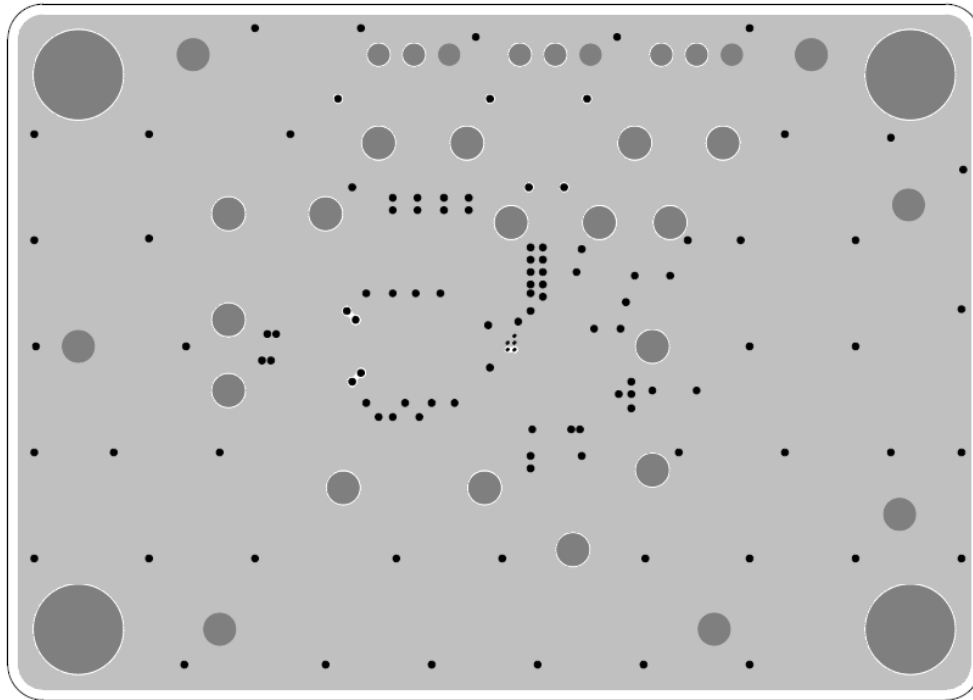


Figure 3. PCB Layout—Inner Side (3rd Layer)

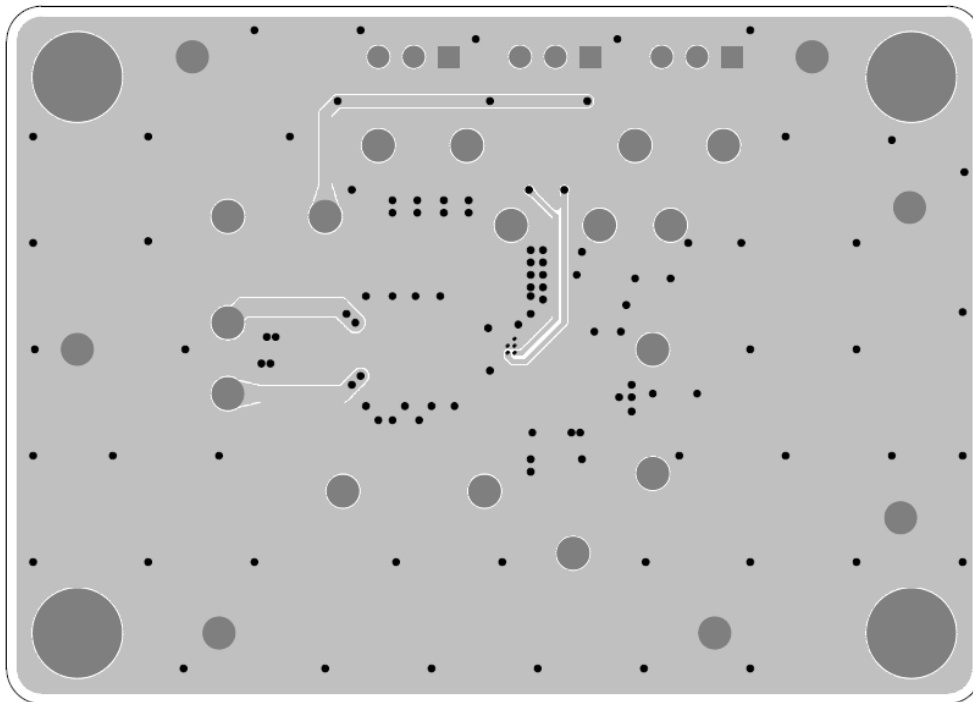


Figure 4. Bottom View (4th Layer)

More Information

For more information, please find the related datasheet or application notes from Richtek website <http://www.richtek.com>.

Important Notice for Richtek Evaluation Board

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